# Quad 2-Input Data Selector/Multiplexer with 3-State Outputs

# **High-Performance Silicon-Gate CMOS**

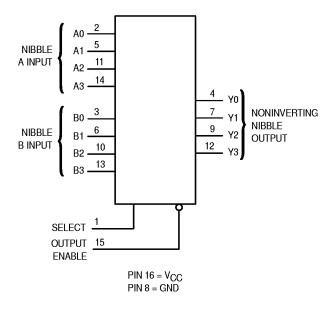
The MC74HC257 is identical in pinout to the LS257. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

This device selects a (4-bit) nibble from either the A or B inputs as determined by the Select input. The nibble is presented at the outputs in noninverted form when the Output Enable pin is at a low level. A high level on the Output Enable pin switches the outputs into the high-impedance state.

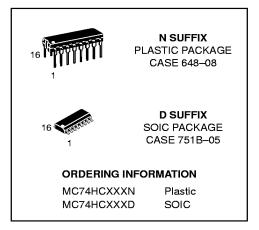
The HC257 is similar in function to the HC157 which do not have 3-state outputs.

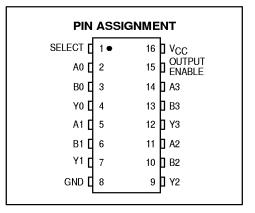
- Output Drive Capability: 15 LSTTL Loads
- · Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: 1 μA
- · High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 108 FETs or 27 Equivalent Gates

#### **LOGIC DIAGRAM**



## **MC74HC257**





### **FUNCTION TABLE**

Inp	Outputs	
Output Enable	Select	Y0 – Y3
Н	Х	Z
L	L	A0 – A3
L	Н	B0 – B3

X = don't care Z = high impedance A0-A3, B0-B3 = the levels of the respective Nibble Inputs.

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#### **MAXIMUM RATINGS\***

Symbol	Parameter	Value	Unit
VCC	DC Supply Voltage (Referenced to GND)	- 0.5 to + 7.0	٧
V <sub>in</sub>	DC Input Voltage (Referenced to GND)	– 1.5 to V <sub>CC</sub> + 1.5	٧
V <sub>out</sub>	DC Output Voltage (Referenced to GND)	- 0.5 to V <sub>CC</sub> + 0.5	٧
l <sub>in</sub>	DC Input Current, per Pin	± 20	mA
lout	DC Output Current, per Pin	± 35	mA
Icc	DC Supply Current, V <sub>CC</sub> and GND Pins	± 75	mA
PD	Power Dissipation in Still Air Plastic DIP† SOIC Package†	750 500	mW
T <sub>stg</sub>	Storage Temperature	- 65 to + 150	°C
TL	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range GND  $\leq$  ( $V_{in}$  or  $V_{out}$ )  $\leq$  VCC. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or VCC). Unused outputs must be left open.

SOIC Package: - 7 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit	
Vcc	DC Supply Voltage (Referenced to GN	D)	2.0	6.0	٧
V <sub>in</sub> , V <sub>out</sub>	DC Input Voltage, Output Voltage (Ref	0	VCC	٧	
TA	Operating Temperature, All Package Types		- 55	+ 125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (Figure 1)	V <sub>CC</sub> = 2.0 V V <sub>CC</sub> = 4.5 V V <sub>CC</sub> = 6.0 V	0 0 0	1000 500 400	ns

### DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

				Guaranteed Limit			
Symbol	Parameter	Test Conditions	V <sub>CC</sub>	– 55 to 25°C	≤ 85°C	≤ 125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage	$V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$ $ I_{out}  \le 20  \mu\text{A}$	2.0 4.5 6.0	1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V
V <sub>IL</sub>	Maximum Low-Level Input Voltage	$V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$ $ I_{out}  \le 20  \mu\text{A}$	2.0 4.5 6.0	0.3 0.9 1.2	0.3 0.9 1.2	0.3 0.9 1.2	V
Voн	Minimum High-Level Output Voltage	$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \le 20 \ \mu\text{A}$	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		$V_{in} = V_{IH} \text{ or } V_{IL}   I_{out}  \le 6.0 \text{ mA}$ $ I_{out}  \le 7.8 \text{ mA}$	4.5 6.0	3.98 5.48	3.84 5.34	3.70 5.20	
V <sub>OL</sub>	Maximum Low-Level Output Voltage	$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \le 20 \mu\text{A}$	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		$V_{\text{in}} = V_{\text{IH}} \text{ or } V_{\text{IL}}   I_{\text{out}}  \le 6.0 \text{ mA}$ $ I_{\text{out}}  \le 7.8 \text{ mA}$	4.5 6.0	0.26 0.26	0.33 0.33	0.40 0.40	
lin	Maximum Input Leakage Current	V <sub>in</sub> = V <sub>CC</sub> or GND	6.0	± 0.1	± 1.0	± 1.0	μΑ
loz	Maximum Three-State Leakage Current	Output in High-Impedance State $V_{in} = V_{IL}$ or $V_{IH}$ $V_{out} = V_{CC}$ or GND	6.0	± 0.5	± 5.0	± 10	μА
lcc	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC}$ or GND $I_{out} = 0 \mu A$	6.0	8	80	160	μΑ

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

<sup>\*</sup> Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

<sup>†</sup>Derating — Plastic DIP: - 10 mW/°C from 65° to 125°C

#### AC ELECTRICAL CHARACTERISTICS (C<sub>1</sub> = 50 pF, Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

			Guaranteed Limit			
Symbol	Parameter	v <sub>CC</sub>	– 55 to 25°C	≤ 85°C	≤ 125°C	Unit
tPLH, tPHL	Maximum Propagation Delay, Nibble A or B to Output Y (Figures 1 and 4)	2.0 4.5 6.0	100 20 17	125 25 21	150 30 26	ns
tPLH, tPHL	Maximum Propagation Delay, Select to Output Y (Figures 2 and 4)	2.0 4.5 6.0	100 20 17	125 25 21	150 30 26	ns
tPLZ, tPHZ	Maximum Propagation Delay, Output Enable to Output Y (Figures 3 and 5)		150 30 26	190 38 33	225 45 38	ns
tPZL, tPZH	Maximum Propagation Delay, Output Enable to Output Y (Figures 3 and 5)		150 30 26	190 38 33	225 45 38	ns
tTLH, tTHL	Maximum Output Transition Time, Any Output (Figures 1 and 4)		60 12 10	75 15 13	90 18 15	ns
C <sub>in</sub>	Maximum Input Capacitance		10	10	10	pF
C <sub>out</sub>			15	15	15	pF

#### NOTES:

- 1. For propagation delays with loads other than 50 pF, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).
- 2. Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

		Typical @ 25°C, V <sub>CC</sub> = 5.0 V	
$C_{PD}$	Power Dissipation Capacitance (Per Package)*	39	pF

<sup>\*</sup> Used to determine the no-load dynamic power consumption: PD = CPD VCC<sup>2</sup>f + ICC VCC. For load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

## **PIN DESCRIPTIONS**

3

#### **INPUTS**

## A0, A1, A2, A3 (Pins 2, 5, 11, 14)

Nibble A input. The data present on these pins is transferred to the output when the Select input is at a low level and the Output Enable input is at a low level. The data is presented to the outputs in noninverted form.

### B0, B1, B2, B3 (Pins 3, 6, 10, 13)

Nibble B input. The logic data present on these pins is transferred to the output when the Select input is at a high level and the Output Enable input is at a low level. The data is presented to the outputs in noninverted form.

#### **OUTPUTS**

## Y0, Y1, Y2, Y3 (Pins 4, 7, 9, 12)

Nibble output. The selected nibble input is presented at these outputs when the Output Enable input is at a low level.

For the Output Enable input at a high level, the outputs are switched to the high impedance state.

### **CONTROL INPUTS**

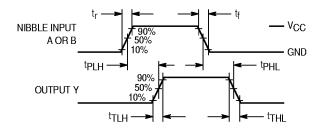
## Select (Pin 1)

Nibble select. This input determines the nibble to be transferred to the outputs. A low level on this input selects the A inputs and a high level selects the B inputs.

### Output Enable (Pin 15)

Output Enable. A low level on this input allows the selected input data to be presented at the outputs. A high level on this input forces the outputs into the high–impedance state.

## **SWITCHING WAVEFORMS**



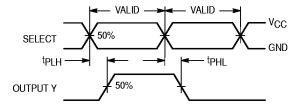


Figure 1.

Figure 2.

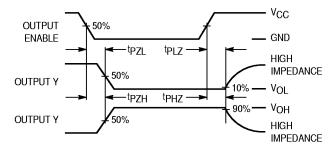
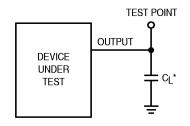
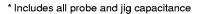
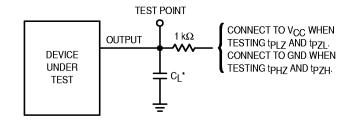


Figure 3.

## **TEST CIRCUITS**





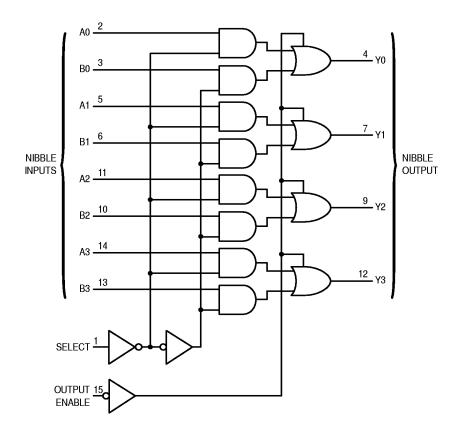


\* Includes all probe and jig capacitance

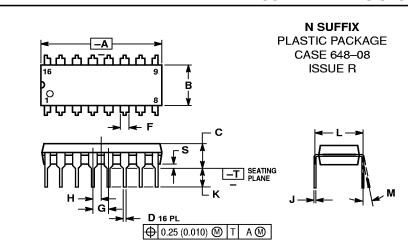
Figure 4.

Figure 5.

## **EXPANDED LOGIC DIAGRAM**



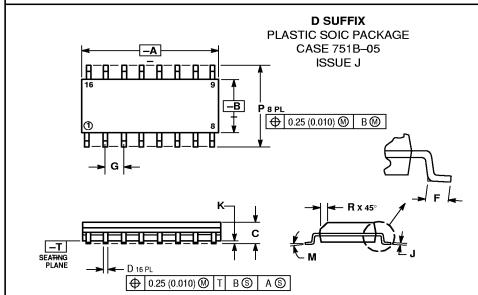
#### **OUTLINE DIMENSIONS**



#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
  DIMENSION L TO CENTER OF LEADS WHEN
- FORMED PARALLEL.
  DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- ROUNDED CORNERS OPTIONAL.

A 0. B 0. C 0. D 0. F 0. G	740 .250 .145	0.770 0.270 0.175	MIN 18.80 6.35	MAX 19.55 6.85
B 0. C 0. D 0. F 0.	250 145	0.270	6.35	
C 0. D 0. F 0.	145			6.85
D 0.		0.175		
F 0.	015		3.69	4.44
Ğ		0.021	0.39	0.53
	.040	0.070	1.02	1.77
	0.	100 BSC	2	2.54 BSC
н	0.	050 BSC	1	.27 BSC
J	.008	0.015	0.21	0.38
K 0	.110	0.130	2.80	3.30
L 0.	295	0.305	7.50	7.74
M	0°	10°	0°	10°
S 0.		0.040	0.51	1.01



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M 1982
- CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS A AND B DO NOT INCLUDE
- MOLD PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION, ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION:

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.2	7 BSC	0.050	D BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
Р	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

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